

PRELIMINARY DATASHEET

500mW QUADRO Mini-MELF Hermetically Sealed Glass Fast Switching Diodes

Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
PD	Power Dissipation	500	mW
T _{STG}	Storage Temperature Range	-65 to +150	°C
TJ	Operating Junction Temperature	+150	°C
W _{IV}	Working Inverse Voltage	75	V
lo	Average Rectified Current	150	mA
I _{FM}	Non-repetitive Peak Forward Current	450	mA
	Peak Forward Surge Current	2	А

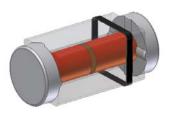
These ratings are limiting values above which the serviceability of the diode may be impaired.

Specification Features:

- Fast Switching Device (T_{RR} <4.0 nS)
- QUADRO Mini-MELF Package
- Surface Device Type Mounting
- Hermetically Sealed Glass
- Compression Bonded Construction
- All External Surfaces Are Corrosion Resistant And Terminals Are Readily Solderable
- RoHS Compliant
- Matte Tin (Sn) Lead Finish
- Color band Indicates Negative Polarity

Electrical Characteristics T_A = 25°C unless otherwise noted

Symbol	Parameter		Test Condition	Limits		l Incid
		rest Condition	Min	Max	Unit	
Вν	Breakdown Voltage	I _R =100μΑ	100		Volts	
		I _R =5μA	75			
I _R Reverse	Reverse Leakage Curre	ent	V _R =20V		25	nA
			V _R =75V		5	μA
VF	Forward Voltage	TCLS4448, TCLS914B	I _F =5mA	0.62	0.72	
		TCLS4148	I _F =10mA		1.0	Volts
		TCLS4448, TCLS914B	I _F =100mA		1.0	Volio
T _{RR} R	Reverse Recovery Time)	I _F =I _R =10mA			
			R _L =100Ω		4	nS
			I _{RR} =1mA			
С	Capacitance		$V_R=0V$, f=1 M_{HZ}		4	pF



Cathode Band Color : Black

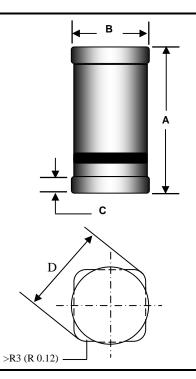


ELECTRICAL SYMBOL



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Package Outline



DIM	QUADRO Mini-MELF			
	Millimeters		Inches	
	Min	Max	Min	Max
А	3.30	3.70	0.130	0.146
В	1.40	1.60	0.055	0.063
С	0.35	0.45	0.014	0.018
D	Typical 1.8		Typical 0.071	

Case Outline

Notes:

- 1. 2.
- JEDEC DO-213 AA Polarity Denoted by a Band.



NOTICE

The information presented in this document is for reference only. Tak Cheong reserves the right to make changes without notice for the specification of the products displayed herein.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of with would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Tak Cheong Semiconductor Co., Ltd., or anyone on its behalf, assumes no responsibility or liability for any damagers resulting from such improper use of sale.

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